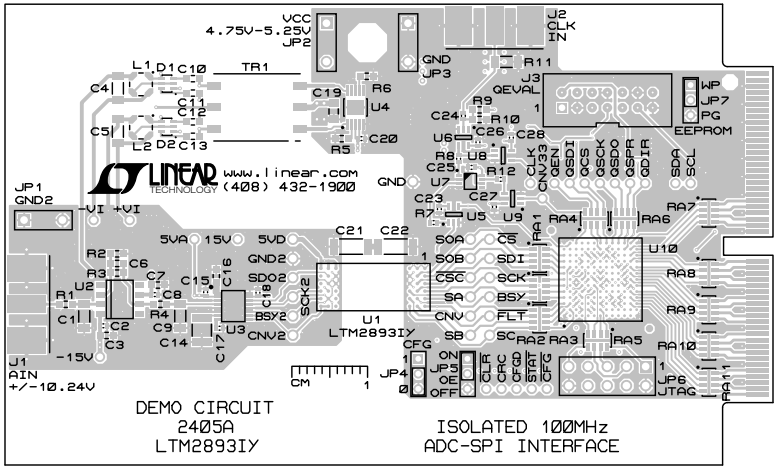
REVISION HISTORY				
ECO	REV	DESCRIPTION	APPROVED	DATE
-	2	2ND PROTOTYPE	KWB	11-4-15

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610
2. MAXIMUM SOLDER TEMPERATURE IS 250 DEGREES CELSIUS
3. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD
4. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
5. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP AND BOTTOM SIDE SMD
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD
7. INSTALL SHUNTS AS SHOWN



TOP SILKSCREEN LAYER
LINEAR TECHNOLOGY
DC2405A-2 * LTM2893IY
ISOLATED 100MHz ADC - SPI INTERFACE
DATE: 11-4-15

APPROVALS	
PCB DES.	KWB
APP ENG.	KWB
SCALE = 1:1	

LINEAR TECHNOLOGY
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Milpitas, CA 95035
Phone: (408) 432-1900
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www.linear.com

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TITLE: TOP ASSEMBLY DRAWING
ISOLATED 100MHz ADC - SPI INTERFACE

SIZE	IC NO.	REV.
N/A	LTM2893IY DEMO CIRCUIT 2405A	2

DATE: Wednesday, November 4th, 2015

SHEET 1 OF 1